WEST Search History

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10/649,087

DATE: Tuesday, March 29, 2005

Hide?	Set Name	Query	Hit Count
		DB=PGPB,USPT,EPAB,JPAB,TDBD; PLUR=YES; OP=OR	
☐	L20	l17 or L19	157
☐	L19	bonding and L18	46
☐	L18	l3 not L17	114
☐	L17	l7 or L16	111
☐	L16	l15 or l6	111
☐	L15	L14 not l6	48
☐	L14	(copper or cu) and L13	52
☐	L13	semiconductor and metallization and (six adj2 level)	75
☐	L12	L11 not l6	0
☐	L11	"metal-six copper"	7
☐	L10	"metal-six cu pad"	0
☐	L9	"metal-six copper pad"	0
☐	L8	L7 not l6	0
☐	L7	"m6 cu pad"	7
☐	L6	l4 or L5	63
☐	L5	electroless and l3	55
☐	L4	l2 and L3	32
☐	L3	("metal-six" or m6) and (copper or cu) and pad	177
		DB=PGPB,USPT; PLUR=YES; OP=OR	
☐	L2	(428/674 or 428/675 or 428/671 or 428/620 or 428/704 or 438/612 or 438/622 or 438/648 or 438/650 or 438/652 or 438/656 or 438/666 or 438/678 or 438/685 or 438/686 or 438/687 or 257/758 or 257/762 or 257/763 or 257/761 or 257/764 or 257/765 or 257/766)![CCLS]	13987
		DB=PGPB,USPT,EPAB,JPAB,DWPI,TDBD; PLUR=YES; OP=OR	
☐	L1	"m6 cu"	9

END OF SEARCH HISTORY

h   e b   b cg b   chh   e   f ff e ·ch   e